

GZP6818AQ

Pressure Sensor

Analog Output

Datasheet

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Document Revision History

Revision	Describe	Date
V1.0	Initial release	2024.12.03
V1.1	Change PIN Diagram	2025.03.13
V1.2	Update Automotive Grade Standard	2025.04.17

The company reserves the right to make changes in the specifications contained herein
without further notice.

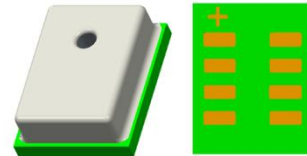
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1 Product Description

The GZP6818AQ pressure sensor is a compact MEMS pressure sensor designed particularly for a wide applications with various pressure range. It is composed of a silicon piezoresistive pressure sensing chip and a signal conditioning integrated circuit. The initial signal from the sensing chip is amplified, temperature compensated, calibrated and finally converted to a high level analog output voltage that is proportional to the applied pressure.

1.1 Features

- Multiple range from 0kpa to 2500kpa
- Absolute pressure type
- 3.3V or 5V power supply optional
- Standard voltage output or proportional voltage output optional
- Pressure range can be customized
- AEC-Q00 and AEC-103 qualified



1.2 Application

- Automotive seat pressure detection
- Intake air pressure detection
- Air pump pressure detection
- Tire pressure detection

2 Function Description

This product is made with advanced micro-electromechanical principles . The core technology is a MEMS pressure sensor chip based on the silicon piezoresistive effect and a high-performance signal conditioning ASIC chip. The silicon micro-piezoresistive MEMS pressure sensor chip outputs a voltage signal proportional to the measured pressure through a Wheatstone bridge composed of four strain-sensitive resistors. The signal is amplified, temperature compensated and linearized by the ASIC chip to obtain an output voltage that is in a prescribed relationship with the applied pressure. The linearity and temperature compensation of the transfer function are realized by the digital processing circuit in the ASIC. Through the polynomial compensation algorithm and multi-point pressure calibration technology at multiple temperatures, high-precision pressure measurement is achieved within the full operating temperature range.

The transfer function of the pressure sensor is created by the following parameters:

- Minimum and maximum pressure ratings
- Voltage values at minimum and maximum rated pressure
- Clamping voltage

All parameters required for a complete calibration algorithm, such as offset, gain, temperature coefficients of offset and gain, and linearity parameters, are determined after calibration and stored in the E²PROM inside the ASIC.

2.1 Block Diagram

The sensor functional block diagram is shown in Figure 1.

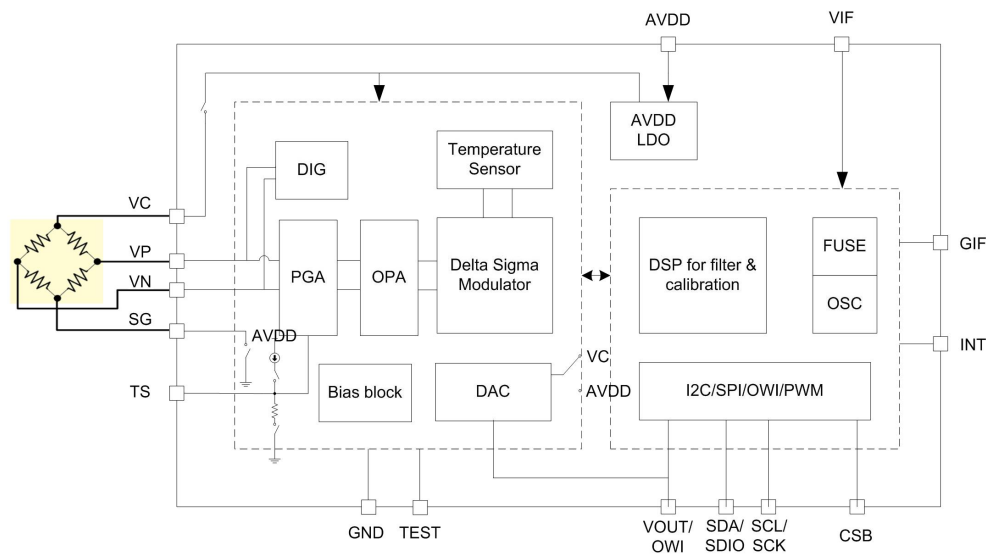


Fig.1 Block Diagram

2.2 Pin Definition

The pin diagram is shown in Figure 2.

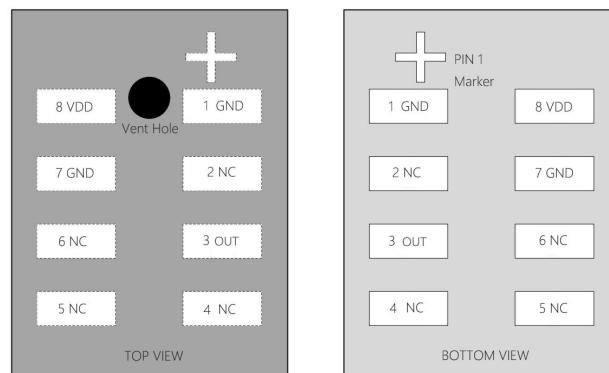


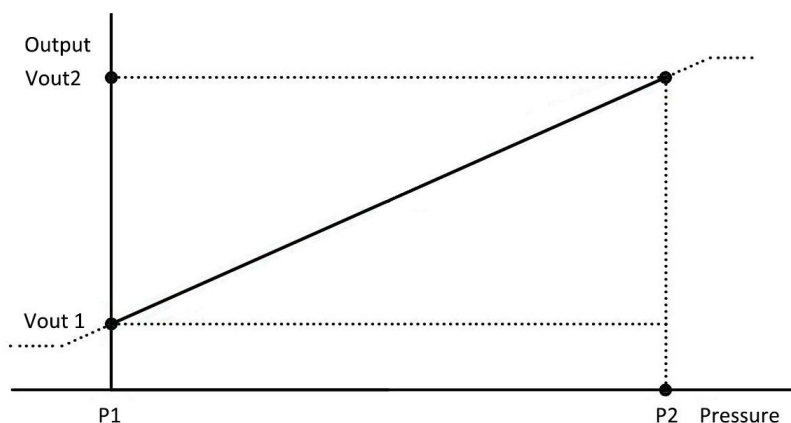
Fig.2 Pin Diagram

Tab.1 Pin correspondence

PIN No.	Description	Remark
1	GND	Negative power input
2	NC	Floating pin
3	Vout	Product output voltage signal
4	NC	Floating pin
5	NC	Floating pin
6	NC	Floating pin
7	GND	Negative power input
8	VDD	Power input positive

2.3 Pressure Function

There is a linear transfer relationship between the sensor's output signal and the applied pressure.


Fig.3 Pressure sensor transfer characteristic curve

The transfer function of the pressure sensor is created by the following parameters:

- Minimum and maximum pressure ratings
- Voltage values at minimum and maximum rated pressure
- Clamping voltage

All parameters required for a complete calibration algorithm, such as offset, gain, temperature coefficients of offset and gain, and linearity parameters, are determined after calibration and stored in the E²PROM inside the ASIC.

Pressure sensor transfer function:

$V_{out} = (K * P + B)$ @ absolute voltage output, VDD = 5 VDC;

$V_{out} = (K * P + B)$ @ absolute voltage output, VDD = 3.3 VDC;

$V_{out} = (K * P + B)/5 * VDD$ @ proportional voltage output;

Of which,

V_{out} : signal output voltage (VDC)

P: Actual pressure (kPa)

P1: Lower limit pressure (kPa)

P2: Upper limit pressure (kPa)

V_{out1} : Lower limit pressure output (V)

V_{out2} : Upper limit pressure output (V)

$K = (V_{out2} - V_{out1}) / (P2 - P1)$

$B = (V_{out1} * P2 - V_{out2} * P1) / (P2 - P1)$

Example Part Number	Pressure range		Output voltage		Transfer function coefficients	
	P1	P2	Vout1	Vout2	K	B
GZP6818AQ40500KPA33Z	40kPa	500kPa	0.2	2.7	0.0054	-0.017
GZP6818AQ40500KPA50K	40kPa	500kPa	0.5	4.5	0.0087	0.152
GZP6818AQ40500KPA33E	40kPa	500kPa	0.1*3.3	0.9*3.3	0.0057	0.100

2.4 Accuracy

The accuracy of the GZP6818AQ pressure sensor is composed of its linearity, repeatability, and hysteresis errors. The value calculated by the transfer function is the specified value of the sensor and also the theoretical value. The error of the sensor is equal to the difference between the actual output voltage value of the sensor under the specified input pressure and the specified output voltage value.

Overall accuracy

The overall accuracy includes more error sources based on the product accuracy:

(1) Pressure drift: The output deviation between the actual output voltage at zero point and full scale and the specified output voltage within the specified pressure range.

(2) Temperature effect: The output deviation of zero point and full scale at different temperatures within the temperature range.

(3) The overall accuracy is expressed by an error band, which consists of three line segments. The data are shown in Figure 4 and Table 2.

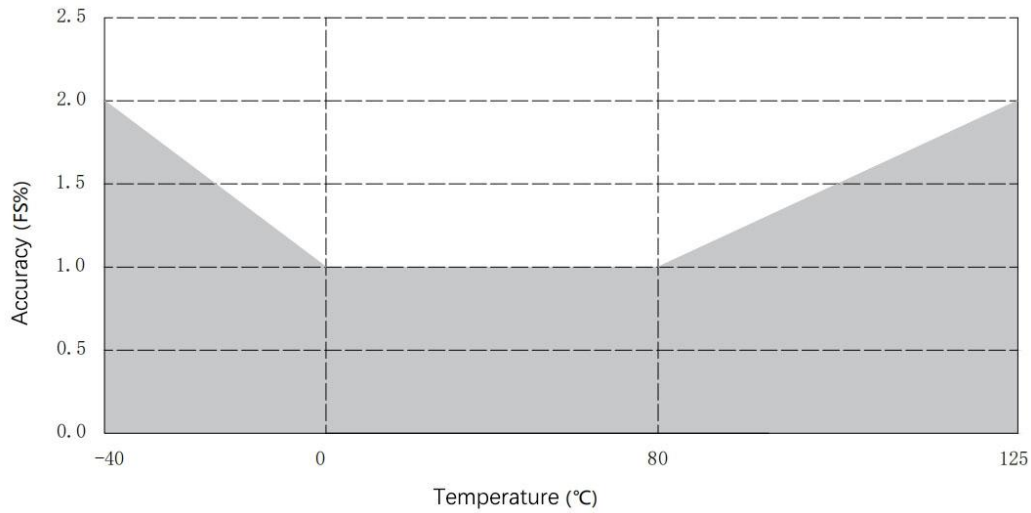


Fig.4 Relationship between overall accuracy and temperature

Tab.2 Overall accuracy table

Temperature(°C)	Overall accuracy (Full Span)
-40~125	±2.0%
0~80	±1.0%

*Different pressure ranges have different overall accuracy, please consult customer service for more details.

3 Technical Indicators

The following indicators of the pressure sensor core are measured under the following conditions:

Measuring medium: Air

Medium temperature: (25±1)°C

Ambient temperature: (25±1)°C

Vibration : 0.1g(1m/s²) Max

Humidity: (50%±10%)RH

Tested power supply: (5±0.005)V DC

3.1 Maximum Ratings

The maximum rated parameters of the sensor are shown in Table 3.

Tab.3 The maximum rated parameters of the sensor

Parameter	Minimum	Typical	Maximum	Unit	Remark
Maximum voltage			6.5	V	
Output current load			5	mA	
ESD Protection		±2		KV	
Operating temperature	-40		125	°C	
Storage temperature	-40		125	°C	

3.2 Performance Indicators

The sensor performance indicators are shown in Table 4.

Tab.4 Sensor performance indicators

Parameter	Value	Unit
Output signal	0.5-4.5 (customizable)	V
Accuracy	±1 (0~80°C)	%Span
Overload pressure	2× (range ≤ 350kPa)	Rated
	1.5× (range>350kPa)	
Burst pressure	3× (range ≤ 350kPa)	
	2× (range>350kPa)	
Compensation temperature	0 ~ 60 (customizable)	°C

1. The 0.5~4.5V output voltage is based on 5V power supply or optional 0.2~2.7V output based on 3.3V power supply. The output can be customized to other voltage range by order.
2. The different pressure range may have different accuracy, overload and burst pressure , please consult Sencoch for more details.

3.3 Electrical Characteristics

The electrical characteristics of the sensor are shown in Table 5.

Tab.5 The electrical characteristics

Parameter	Min.	Typ.	Max.	Unit	Remark
Supply voltage	3		5.5	V	
Working current		1700		uA	@25°C
Filter capacitor		100		nF	
PSRR		60		dB	
Output current load			5	mA	
Input common mode signal rejection ratio	80	110		dB	
Short circuit current limiting	15	20	25	mA	
Upper clamp voltage	3/4		1	VDD	
Lower clamping voltage	0		1/4	VDD	

4 Application Circuit

Figure 5 is for the recommended application circuit of the chip.

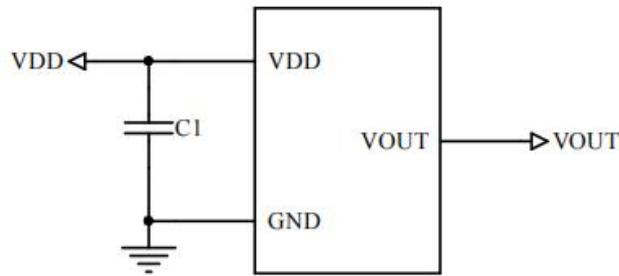


Fig.5 Application circuit

Notice:

- The recommended value of C1 is 100nF. Please confirm the electrical definition before assembly.
- Do not have any electrical connection to the NC pin, otherwise it may cause product failure.
- Provide anti-static protection during welding
- Overload voltage (6.5Vdc) may burn out the circuit chip
- This product has no reverse connection protection, please pay attention to the power polarity during assembly

5 Appearance and Structure

The sensor dimensions refer to Figure 6. (Error $\pm 0.1\text{mm}$ if not specified)

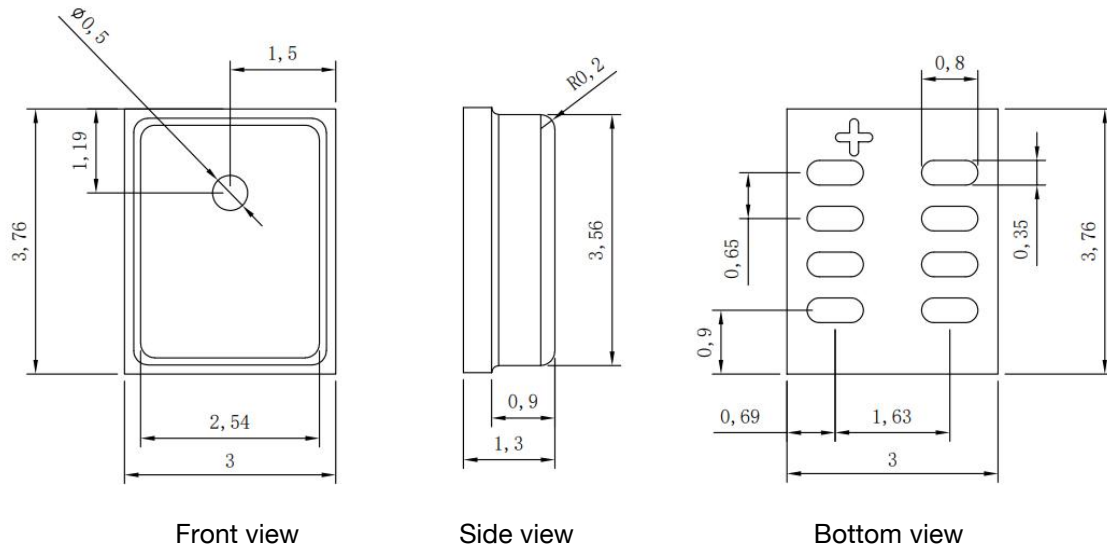


Fig.6 Sensor Dimensions

Recommended footprint as Figure 7

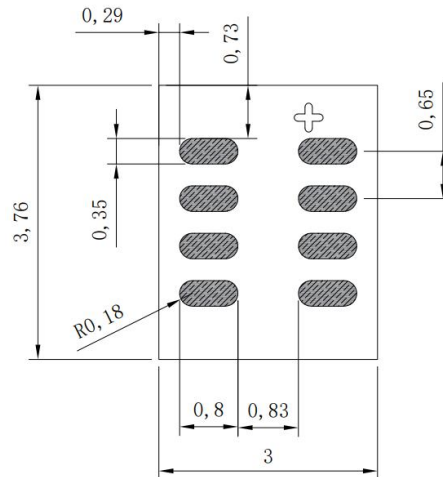


Fig.7 Recommended Footprint

6 Order Guide

6.1 Common Range Order Guide

GZP 6818AQ 50400KPA 50K B01 WX

Tab.6 Selection Guide

GZP	Pressure Sensor Series
68 18	Product Series
AQ	Output type A: Analog output Q: Automotive Grade
50400KPA	Pressure range: 50400 means the minimum pressure (50) and the maximum pressure (400) Pressure unit: KP: KPa MP :MPa PS: PSi BA:Bar Pressure Type: A: Absolute Therefore, 50400KPA means the absolute pressure of 50KPA to 400KPA.
50	Power supply 50: 5 Vdc; 33 : 3.3Vdc
K	Output K: 0.5~4.5 V Z : 0.2~2.7V H:0.2~4.7V E: Proportional voltage output (note the output voltage range after the model)
B01	Packing method B01: Taping
WX	Company interior code

6.2 Custom Range Order Guide

GZP 6818AQ A017 T014 B01WX

Tab.7 Selection Guide

GZP	Pressure Sensor Series
6818	Product Series
AQ	Output type A: Analog output Q: Automotive Grade
A017	Pressure range A017: 21.336~101.336kPa For other custom range codes, please consult the manufacturer.
T014	Power supply, output T025 0.76~4.64V@5V For other custom power supplies and output codes, please consult the manufacturer.
B01	Packing method B01: Taping
WX	Company interior code

7 Model Example

Tab.8 Model example

	Pressure range	Model	Power supply/output
Common range output	0 ~ 700kPa	GZP6818AQ00 700KPA33ZB01WX	0.2~2.7V@3.3V
	40 ~ 500kPa	GZP6818AQ40 500KPA50KB01WX	0.5~4.5V@5.0V
	101.3 ~ 1570kPa	GZP6818AQ00 1570KPA50KB01WX	0.5~4.5V@5.0V
Custom range output	20~100kPa	GZP6818AQA016T014B01WX	0.4791~3.9271 V@5.0V
	20~100kPa	GZP6818AQA016T103B01WX	0.5~4.7V@5.0V
	20~115kPa	GZP6818AQA063T066B01WX	0.79~4.54 @5.0V
	20~120kPa	GZP6818AQA161T127B01WX	0.88~4.88 @5.0V
	21.336~101.336kPa	GZP6818AQA017T025B01WX	0.76~4.64V@5.0V
	45~350kPa	GZP6818AQA019T032B01WX	0.5~4.47V@5.0V

1.Above model example is for order information only, contact Sencoch for production and stock status.

2.For more customized ranges and special parameter part numbers, please consult Sencoch or agents.

8 Instruction for Use

8.1 Soldering

Since this product has a small structure with low heat capacity, please minimize the influence of heat from the outside. Otherwise, it may be damaged due to thermal deformation and cause changes in characteristics. Please use non-corrosive rosin type flux . In addition, since the product is exposed to the outside, please be careful not to allow flux to penetrate into the inside.

(1) Manual soldering

- Please use a soldering iron with a head temperature of 260 to 300°C (30 W) and perform the work within 5 seconds.

- When soldering with a load applied to the terminals, please be careful as the output may change.
- Please keep the soldering iron tip clean.

(2) Reflow soldering (SMD terminal type)

To avoid zero drift after reflow, it is recommended to use low temperature solder paste for reflow oven. The temperature setting conditions are as follows:

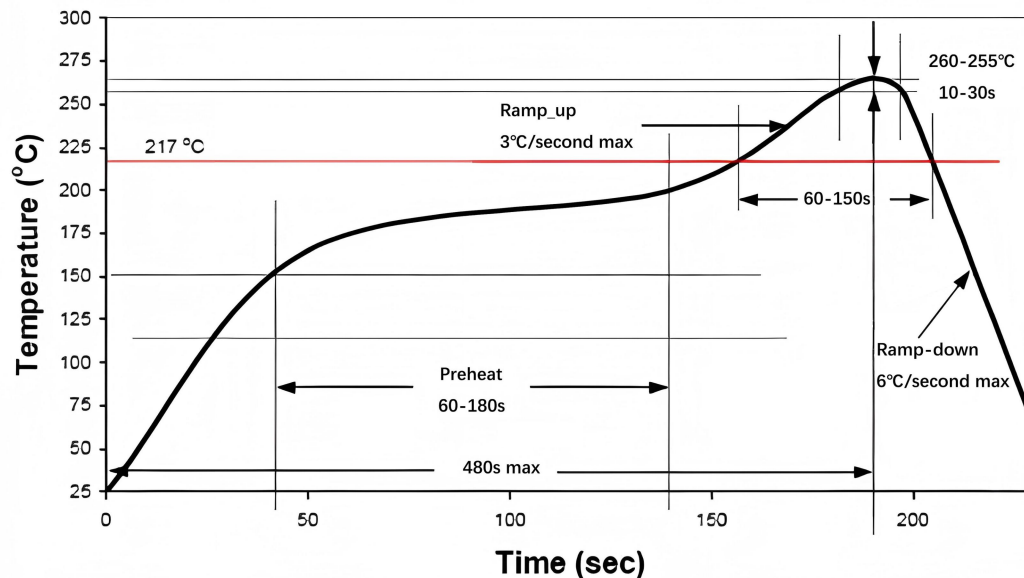


Fig.8 Reflow soldering

(3) The warping of the printed circuit board relative to the entire sensor should be kept below 0.05mm. Please manage this.

(4) When cutting and bending the substrate after mounting the sensor, be careful not to cause stress on the soldered parts .

(5) Since the sensor terminals are exposed, if metal pieces touch the terminals, abnormal output may occur. Be careful not to touch them with metal pieces or your hands.

(6) When coating is applied after soldering to prevent insulation degradation of the substrate, be careful not to allow chemicals to adhere to the sensor surface.

8.2 Cleaning requirements

(1) Since this product is an open type, be careful not to allow cleaning fluid to enter the interior.

Please avoid using ultrasonic cleaning as it may cause product failure .

8.3 Storage and transportation

(1) This product is not drip- proof, so do not use it in locations where it may be splashed with water.

(2) Do not use the product in an environment where condensation occurs. If moisture

attached to the sensor chip freezes, it may cause a change in sensor output or damage the sensor.

(3) Due to the structure of the pressure sensor chip, the output will change when it is exposed to light. Especially when applying pressure through a transparent cover, etc., please avoid light from reaching the sensor chip.

(4) Normally packaged pressure sensors can be transported by ordinary transportation tools. Please note: The product should be protected from moisture, impact, sunburn and pressure during transportation.

8.4 Other precautions for use

(1) Incorrect installation methods may cause accidents, so please be careful.

(2) Avoid using the product in a manner that applies high-frequency vibrations, such as ultrasonic waves.

(3) The only pressure media that can be used directly are air and non-corrosive gases. Other media, especially corrosive media or media containing foreign matter, may cause malfunctions and damage, so please avoid using it in the above environments.

(4) A pressure sensor chip is located inside the pressure inlet. If a needle or other foreign object is inserted into the pressure inlet, the chip may be damaged or the inlet may be blocked, so please avoid such operations. Also, please avoid blocking the air inlet during use .

(5) Please use the product within the rated pressure range. Using the product outside the rated pressure range may cause damage.

(6) Since static electricity may cause damage, please be careful to ground charged objects on the table and workers when using it to safely discharge static electricity in the surrounding area.

(7) Please pay full attention to the fixing and selection of the product, sleeve, and introduction tube according to the pressure used.

(8) Since this specification is for a single product, in order to improve reliability during actual use, please confirm the performance and quality under actual use conditions.

9 Packaging Information

Carrier tape information as shown in Figure 10 (unit: mm) Quantity per tray 3000 PCS

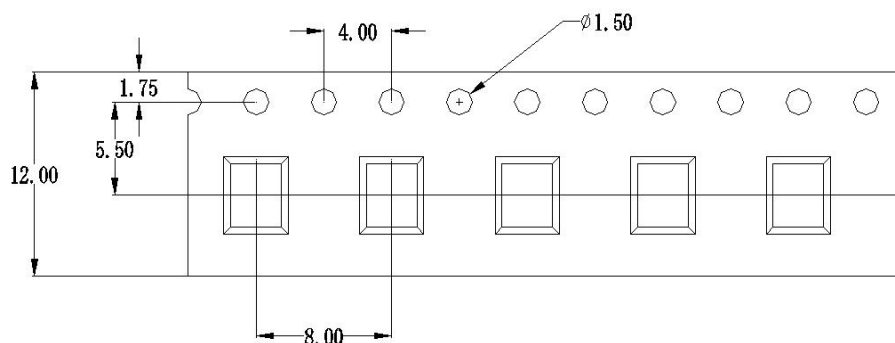


Fig.9 Carrier tape

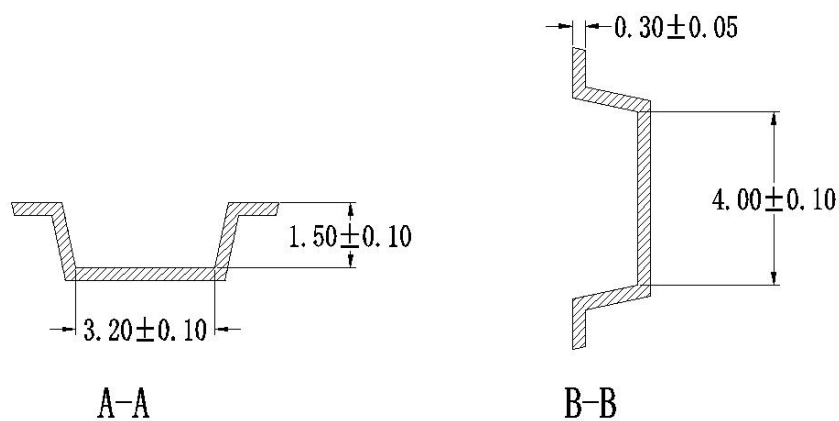


Fig.10 Detail of the carrier pocket

Safety Precautions

This product is made of semiconductor components for general electronic equipment (communication equipment, measuring equipment, working machinery, etc.). Products using these semiconductor components may malfunction and fail due to external interference and surges, so please confirm the performance and quality under actual use. To be on the safe side, please perform safety design on the device (setting of protection circuits such as fuses and circuit breakers, multiple devices, etc.) so that life, body, property, etc. will not be harmed in the event of a malfunction. To prevent injuries and accidents, please be sure to comply with the following matters:

- The driving current and voltage should be used below the rated values.

Please wire according to the electrical definition . In particular, reverse connection of the power supply may cause accidents due to circuit damage such as heat, smoke, and fire, so please be careful.

- Be careful when fixing the product and connecting the pressure inlet .

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